TOSHIBA BI-DIRECTIONAL TRIODE THYRISTOR SILICON PLANAR TYPE

SM12GZ47, SM12JZ47, SM12GZ47A, SM12JZ47A

AC POWER CONTROL APPLICATIONS

Repetitive Peak off-State Voltage : VDRM = 400V, 600V

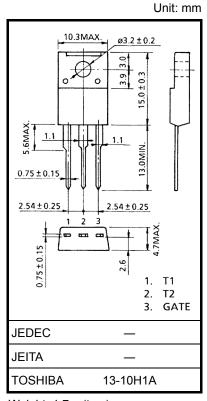
• R.M.S On-State Current : I_T (RMS) = 12A

• High Commutating (dv / dt)

• Isolation Voltage : $V_{Isol} = 1500V AC$

ABSOLUTE MAXIMUM RATINGS

CHARACTERI	STIC	SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage and	SM12GZ47 SM12GZ47A	V _{DRM}	400	V	
Repetitive Peak Reverse Voltage	SM12JZ47 SM12JZ47A	V DKM	600	V	
R. M. S. On-state Curre (Full Sine Waveform TC		I _{T (RMS)}	12	Α	
Peak One Cylce Surge On-State		l=a	120 (50Hz)	Α	
Current (Non-Repetitive	e)	I _{TSM}	132 (60Hz)	^	
I ² t Limit Value		I ² t	72	A ² s	
Critical Rate of Rise of C Current	On-State (Note 1)	di / dt	50	A / μs	
Peak Gate Power Dissip	ation	P_{GM}	5	W	
Average Gate Power Di	ssipation	P _{G (AV)}	0.5	W	
Peak Gate Voltage		V_{FGM}	10	V	
Peak Gate Current		I _{GM}	2	Α	
Junction Temperature		Tj	-40~125	°C	
Storage Temperature R	ange	T _{stg}	-40~125	°C	
Isolation Voltage (AC, t	= 1min.)	V _{Isol}	1500	V	



Weight: 1.7 g (typ.)

Note 1: di / dt test condition

 $V_{DRM} = 0.5 \times Rated$ $I_{TM} \le 17A$

 $t_{gW} \ge 10\mu s$ $t_{gr} \le 250ns$ $t_{gp} = t_{GT} \times 2.0$

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

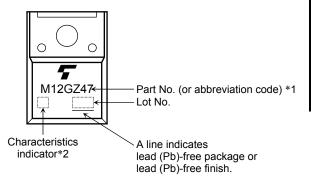
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).



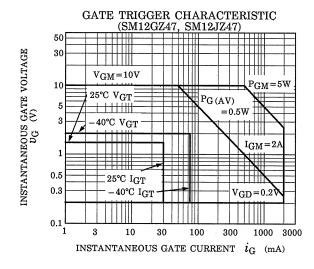
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

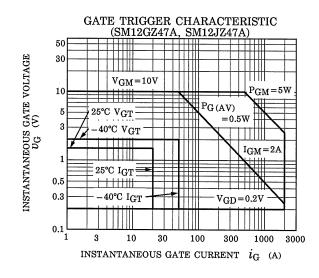
CHARACTERISTIC		SYMBOL	TEST CONDITION		MIN	TYP.	MAX	UNIT		
Repetitive Peak Off-State Current		I _{DRM}	V _{DRM} = Rated		_	_	20	μA		
Gate Trigger Voltage				T2 (+) , Gate (+)	_	_	1.5			
		II		$V_D = 12V$, $R_L = 20\Omega$	T2 (+) , Gate (-)	-	_	1.5	V	
		III			T2 (-) , Gate (-)		_	1.5		
		IV			T2 (-) , Gate (+)		_	_		
Gate Trigger Current SM			I			T2 (+) , Gate (+)		_	30	
	SM12	SM12GZ47				T2 (+) , Gate (-)		_	30	1
	SM12	SM12JZ47	III			T2 (-) , Gate (-)		_	30	1
					V _D = 12V,	T2 (-) , Gate (+)	_	_	_	
		SM12GZ47A SM12JZ47A	I	lgт	R _L = 20Ω	T2 (+) , Gate (+)		_	20	mA
	SM12		II			T2 (+) , Gate (-)		_	20	
	SM12		III			T2 (-) , Gate (-)		_	20	
			IV			T2 (-) , Gate (+)	1	_	_	
Peak On-State Voltage		V _{TM}	I _{TM} = 17A		-	_	1.5	V		
Gate Non-Trigger Voltage		V_{GD}	V _D = Rated, Tc = 125°C		0.2	_	_	٧		
Holding Current		lΗ	V _D = 12V, I _{TM} = 1A		_	_	50	mA		
Thermal Resistance		R _{th (j-c)}	Junction to Case, AC		_	_	3.0	°C / W		
Critical Rate of Rise of Off-State Voltage	SM12GZ47 SM12JZ47	12JZ47		V _{DRM} = Rated, T _j = 125°C Exponential Rise		_	300	_	- V / μs	
	SM12GZ47A SM12JZ47A		dv / dt			_	200	_		
Critical Rate of Rise of Off–State Voltage at Commutation	9	SM12GZ47 SM12JZ47		(4/44) -	V _{DRM} = 400V, T _j = 125°C (di / dt) c = -6.5A / ms		10	_	_	- V/μs
	SM12GZ47 SM12JZ47		(dv / dt) c	4			_	_		

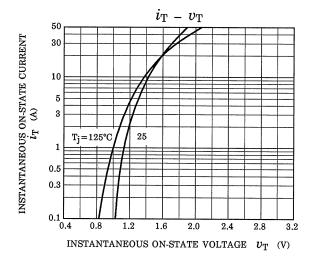
MARKING

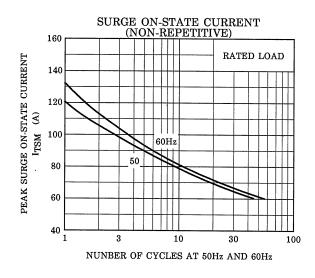


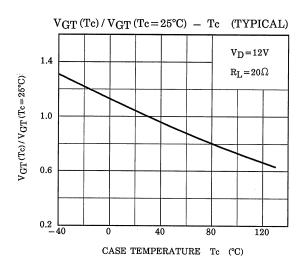
	Part No. (or abbreviation code)	Part No.
*1 -	M12GZ47	SM12GZ47, SM12GZ47A
	M12JZ47	SM12JZ47, SM12JZ47A
*2	Nothing	SM12GZ47, SM12JZ47
	A	SM12GZ47A, SM12JZ47A

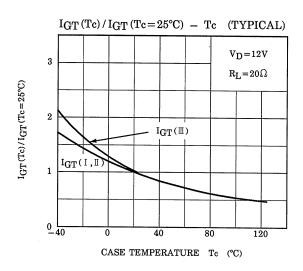


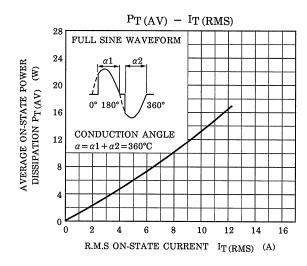


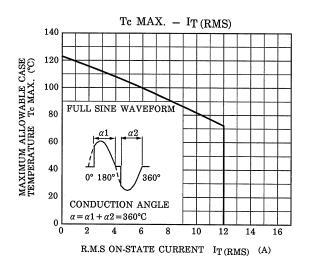


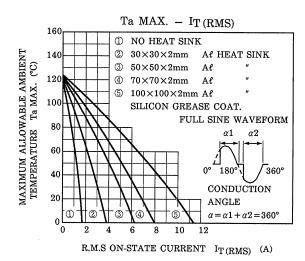


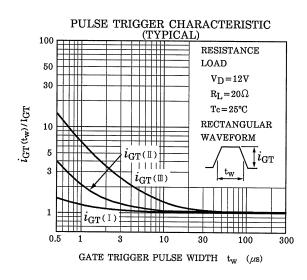


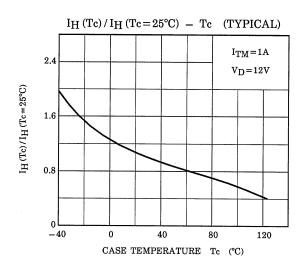


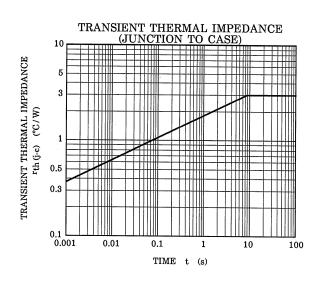












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